



(0,635 mm) .025"

**MEC6-DV SERIES** 

(21,06)

829

(24 87)

.979

1.129

50

60

70

(36,49)

1 437

(42 84)

1.687 (49,19)

1.937

# **VERTICAL MICRO EDGE CARD SO**

### **SPECIFICATIONS**

For complete specifications and recommended PCB layouts see www.samtec.com?MEC6-DV

Insulator Material:

Black LCP
Contact Material: Phosphor Bronze Plating: Au or Sn over

50μ" (1,27 μm) Ni Operating Temp Range: -55°C to +125°C

Insertion Depth: (4,22 mm) .166" to (5,66 mm) .223" **Current Rating:** 1.7 A per pin (6 adjacent pins powered)

Voltage Rating: 210 VAC **RoHS Compliant:** Yes

# **Processing:**

Lead-Free Solderable:

SMT Lead Coplanarity: (0,10 mm) .004" max (10-50) (0,15 mm) .006" max (60-70)

### RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



## **ALSO AVAILABLE** (MOQ Required)

- Locking Clip (Manual placement required)
- Other platings Contact Samtec

#### Notes:

While optimized for 50Ω applications, this connector with alternative signal/ground patterns may also perform well in certain  $75\Omega$  applications. Contact Samtec for further information.

Some sizes, styles and options are non-standard, nonreturnable.

#### Mates with:

MFC6-DV

8,65 mm Stack Height

Single-Ended Signaling

Differential Pair Signaling

1,60 mm) .062" thick cards





